

Low Current 7 mm Seven Segment Display

| Color | Type | Circuitry |
|---------------------|----------|----------------|
| High efficiency red | TDSL1150 | Common anode |
| | TDSL1160 | Common cathode |

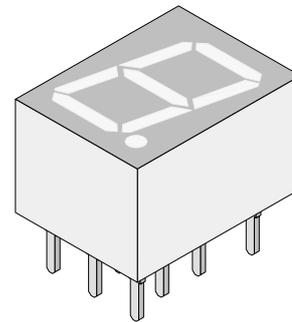
Description

The TDSL11.0 series are 7 mm character seven segment low current LED displays in a very compact package.

The displays are designed for a viewing distance up to 3 meters and available in high efficiency red. The grey package surface and the evenly lighted untinted segments provide an optimum on-off contrast.

All displays are categorized in luminous intensity groups. That allows users to assemble displays with uniform appearance.

Typical applications include instruments, panel meters, point-of-sale terminals and household equipment.



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Features

- Low power consumption
- Suitable for DC and multiplex operation
- Evenly lighted segments
- Grey package surface
- Untinted segments
- Luminous intensity categorized
- Wide viewing angle

Applications

Panel meters
Test- and measure- equipment
Point-of-sale terminals
Control units

TDSL11.0

Absolute Maximum Ratings

$T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified

TDSL1150 /TDSL1160

| Parameter | Test Conditions | Type | Symbol | Value | Unit |
|---|--|------|------------|-------------|--------------------|
| Reverse voltage per segment | | | V_R | 6 | V |
| DC forward current per segment | | | I_F | 15 | mA |
| Peak forward current per segment | | | I_{FM} | 45 | mA |
| Surge forward current per segment | $t_p \leq 10 \mu\text{s}$ (non repetitive) | | I_{FSM} | 106 | mA |
| Power dissipation | $T_{amb} \leq 45^{\circ}\text{C}$ | | P_V | 320 | mW |
| Junction temperature | | | T_j | 100 | $^{\circ}\text{C}$ |
| Operating temperature range | | | T_{amb} | -40 to + 85 | $^{\circ}\text{C}$ |
| Storage temperature range | | | T_{stg} | -40 to + 85 | $^{\circ}\text{C}$ |
| Soldering temperature | $t \leq 3 \text{ sec}$, 2mm below seating plane | | T_{sd} | 260 | $^{\circ}\text{C}$ |
| Thermal resistance LED junction/ambient | | | R_{thJA} | 180 | K/W |

Optical and Electrical Characteristics

$T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified

Red (TDSL1150 , TDSL1160)

| Parameter | Test Conditions | Type | Symbol | Min | Typ | Max | Unit |
|--|---|------|-------------|-----|----------|-----|----------------|
| Luminous intensity per segment (digit average) ¹⁾ | $I_F = 2 \text{ mA}$ | | I_V | 180 | 260 | | μcd |
| | $I_F = 5 \text{ mA}$ | | I_V | | 1000 | | μcd |
| | $I_F = 20 \text{ mA}$, $t_p/T = 0.25$ | | I_V | | 1300 | | μcd |
| Dominant wavelength | $I_F = 2 \text{ mA}$ | | λ_d | 612 | | 625 | nm |
| Peak wavelength | $I_F = 2 \text{ mA}$ | | λ_p | | 635 | | nm |
| Angle of half intensity | $I_F = 2 \text{ mA}$ | | ϕ | | ± 50 | | deg |
| Forward voltage per segment | $I_F = 2 \text{ mA}$ | | V_F | | 1.8 | 2.4 | V |
| | $I_F = 20 \text{ mA}$ | | V_F | | 2.7 | 3 | V |
| Reverse voltage per segment | $I_R = 10 \mu\text{A}$ | | V_R | 6 | 20 | | V |
| Junction capacitance | $V_R = 0$, $f = 1 \text{ MHz}$ | | C_j | | 30 | | pF |

¹⁾ I_{Vmin} and I_V groups are mean values of segments a to g

Typical Characteristics ($T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified)

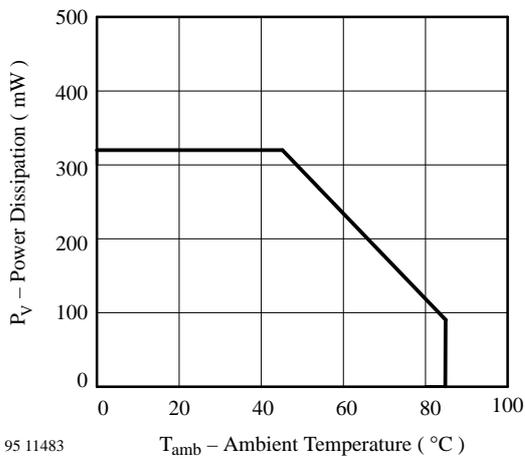


Figure 1. Power Dissipation vs. Ambient Temperature

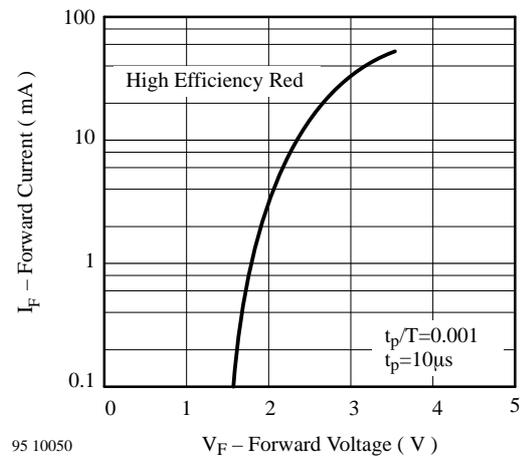


Figure 4. Forward Current vs. Forward Voltage

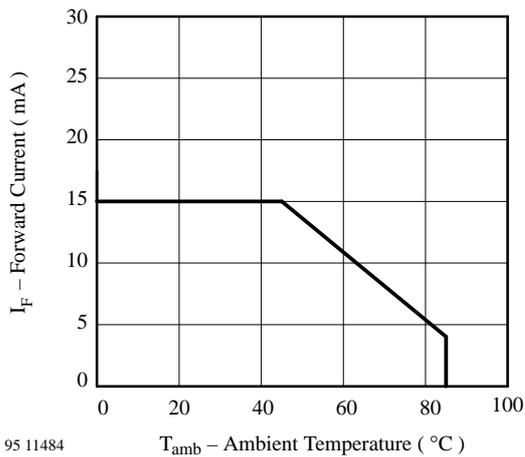


Figure 2. Forward Current vs. Ambient Temperature

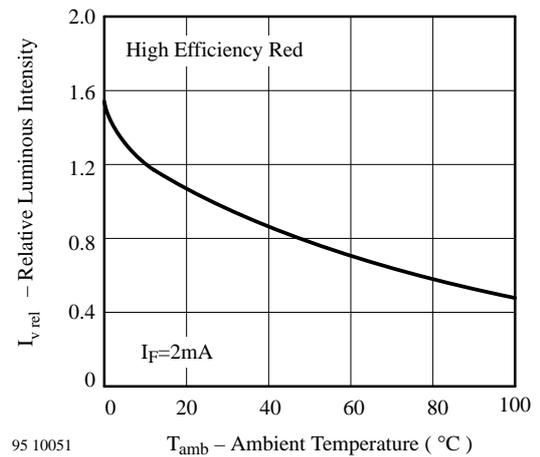


Figure 5. Rel. Luminous Intensity vs. Ambient Temperature

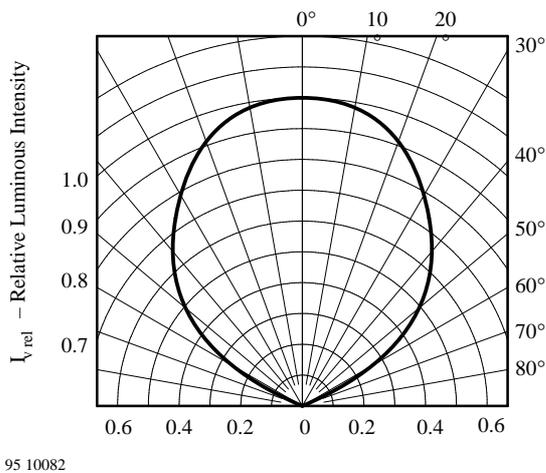


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

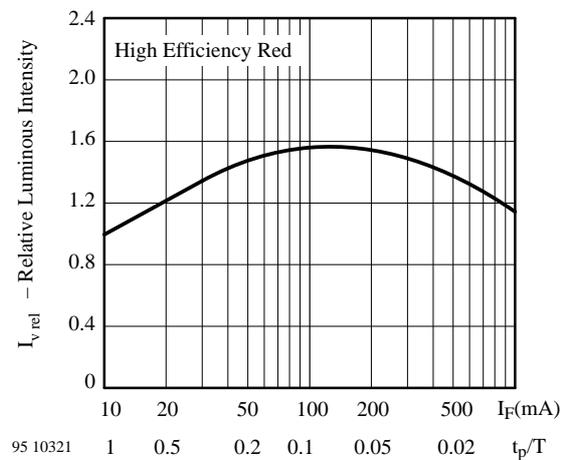


Figure 6. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

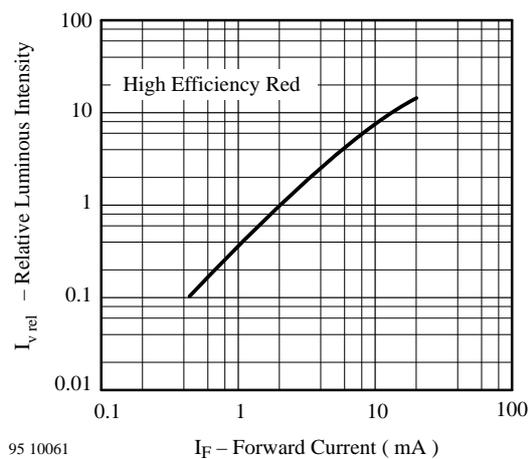


Figure 7. Relative Luminous Intensity vs. Forward Current

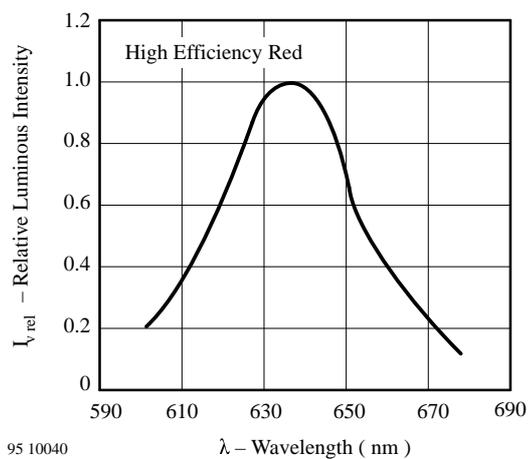
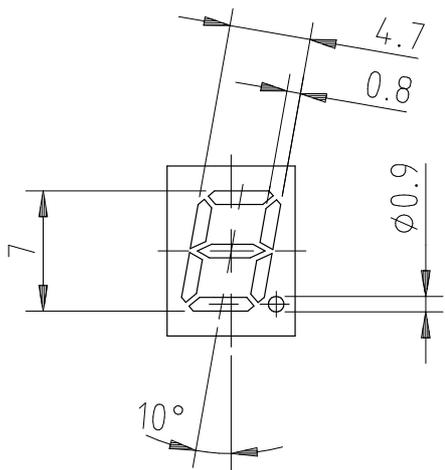
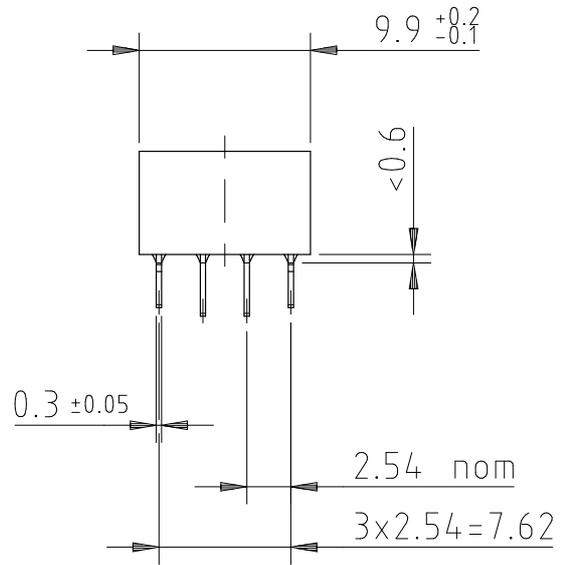
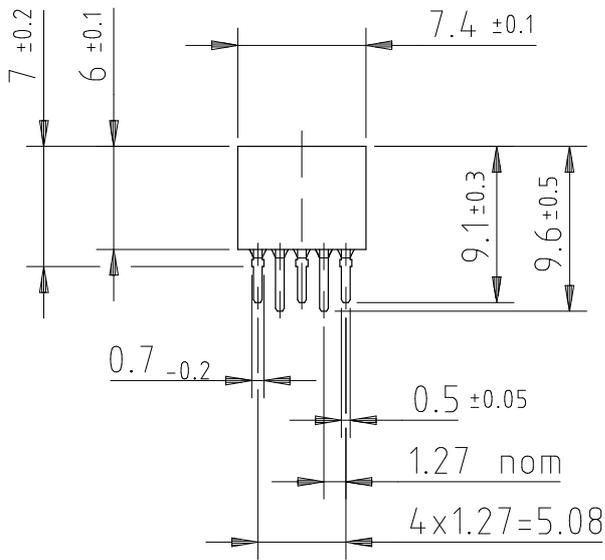
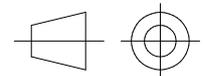


Figure 8. Relative Luminous Intensity vs. Wavelength

Dimensions in mm

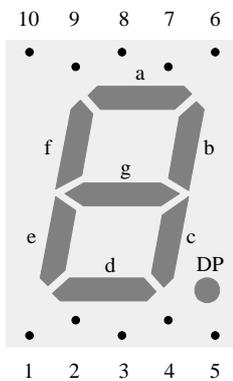


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technical drawings
according to DIN
specifications

Pin connections



- 1 e
- 2 d
- 3 A (C)
- 4 c
- 5 DP
- 6 b
- 7 a
- 8 A (C)
- 9 gg
- 10 f

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Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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